

ATTORNEY DOCKET NO: SUG-017-USA-P

**DECLARATION AND POWER OF ATTORNEY**

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**INJECTION MOLDING METHOD AND INJECTION MOLDING APPARATUS**

The specification of which is  attached and/or  was filed on .....as application Serial No. .... and was amended on (if applicable) .....

international (PCT) application No. .... filed

.....and as amended on .....(if any).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

| COUNTRY | APPLICATION NUMBER | DATE OF FILING | PRIORITY CLAIMED UNDER<br>35 U.S.C. 119                             |
|---------|--------------------|----------------|---|
| JAPAN   | 2001-165388        | May 31, 2001   | <input type="checkbox"/> YES <input checked="" type="checkbox"/> NO |
| JAPAN   | 2003-196425        | July 14, 2003  | <input checked="" type="checkbox"/> YES <input type="checkbox"/> NO |

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

| APPLICATION NUMBER | DATE OF FILING | STATUS (Patented, Pending, Abandoned) |
|--------------------|----------------|---------------------------------------|
|                    |                |                                       |

I hereby appoint the follow attorneys to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Law Office of Townsend & Banta: Donald E. Townsend, Registration No. 22, 069; Donald E. Townsend, Jr. Registration No. 43, 198. Please address all correspondence to the Law Offices of Townsend & Banta, 601 Pennsylvania Avenue, N.W., Suite 900, South Building, Washington, D.C. 20004.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

|   |                      |              |
|---|----------------------|--------------|
| FULL NAME OF FIRST INVENTOR<br>RESIDENCE  | INVENTOR'S SIGNATURE | DATE         |
| c/o DAIWA KASEI INDUSTRY CO., LTD.,<br>1, Aza Kamihirachi, Hobo-cho, Okazaki-shi, Aichi 444-0004 Japan<br>POST OFFICE ADDRESS | Toshi SAEKI          | Aug. 1. 2003 |
|   |                      | CITIZENSHIP  |
|   |                      | JAPANESE     |
| FULL NAME OF SECOND JOINT INVENTOR, IF ANY<br>RESIDENCE   | INVENTOR'S SIGNATURE | DATE         |
| Makoto SUZUKI   | Makoto Suzuki        | Aug. 1. 2003 |
|   |                      | CITIZENSHIP  |
|   |                      | JAPANESE     |
| FULL NAME OF THIRD JOINT INVENTOR, IF ANY<br>RESIDENCE  | INVENTOR'S SIGNATURE | DATE         |
| c/o DAIWA KASEI INDUSTRY CO., LTD.,<br>1, Aza Kamihirachi, Hobo-cho, Okazaki-shi, Aichi 444-0004 Japan<br>POST OFFICE ADDRESS |                      |              |
|   |                      | CITIZENSHIP  |
|   |                      | JAPANESE     |

Listing of inventors Continued on Page 2 hereto.  Yes  No

LAW OFFICES OF TOWNSEND & BANTA

WASHINGTON, D.C.

ATTORNEY DOCKET NO: SUG-017-USA-P

Listing of Inventors Continued from Page 1 of Declaration and Power of Attorney for invention entitled:  
INJECTION MOLDING METHOD AND INJECTION MOLDING APPARATUS

|   |   |  |                         |                        |
|---|---|--|-------------------------|------------------------|
| FULL NAME OF THIRD JOINT INVENTOR, IF ANY<br>Katsumasa ISOGAI | RESIDENCE<br>c/o DAIWA KASEI INDUSTRY CO., LTD.,<br>1, Aza Kamihirachi, Hobo-cho, Okazaki-shi, Aichi 444-0004 Japan | INVENTOR'S SIGNATURE<br>Katsumasa Isogai | CITIZENSHIP<br>JAPANESE | DATE<br>August 1, 2003 |
| FULL NAME OF FOURTH JOINT INVENTOR, IF ANY<br>Kazuhiro HANAI  | RESIDENCE<br>c/o DAIWA KASEI INDUSTRY CO., LTD.,<br>1, Aza Kamihirachi, Hobo-cho, Okazaki-shi, Aichi 444-0004 Japan | INVENTOR'S SIGNATURE<br>Kazuhiro Hanai   | CITIZENSHIP<br>JAPANESE | DATE<br>AUG. 1, 2003   |
| FULL NAME OF FIFTH JOINT INVENTOR, IF ANY<br>Syuulchi HAZAMA  | RESIDENCE<br>c/o DAIWA KASEI INDUSTRY CO., LTD.,<br>1, Aza Kamihirachi, Hobo-cho, Okazaki-shi, Aichi 444-0004 Japan | INVENTOR'S SIGNATURE<br>Syuulchi Hazama  | CITIZENSHIP<br>JAPANESE | DATE<br>AUG 1. 2003    |
| FULL NAME OF SIXTH JOINT INVENTOR, IF ANY                     | RESIDENCE<br>c/o DAIWA KASEI INDUSTRY CO., LTD.,<br>1, Aza Kamihirachi, Hobo-cho, Okazaki-shi, Aichi 444-0004 Japan | INVENTOR'S SIGNATURE                     | CITIZENSHIP             | DATE                   |
| FULL NAME OF SEVENTH JOINT INVENTOR, IF ANY                   | RESIDENCE   | INVENTOR'S SIGNATURE                     | CITIZENSHIP             | DATE                   |
| FULL NAME OF EIGHTH JOINT INVENTOR, IF ANY                    | RESIDENCE   | INVENTOR'S SIGNATURE                     | CITIZENSHIP             | DATE                   |
| FULL NAME OF NINTH JOINT INVENTOR, IF ANY                     | RESIDENCE   | INVENTOR'S SIGNATURE                     | CITIZENSHIP             | DATE                   |
| FULL NAME OF TENTH JOINT INVENTOR, IF ANY                     | RESIDENCE   | INVENTOR'S SIGNATURE                     | CITIZENSHIP             | DATE                   |